

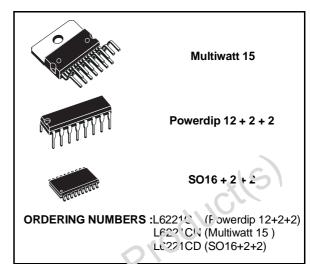
## **QUAD DARLINGTON SWITCH**

- FOUR NON INVERTING INPUTS WITH ENABLE
- OUTPUT VOLTAGE UP TO 60 V
- OUTPUT CURRENT UP TO 1.8 A
- VERY LOW SATURATION VOLTAGE
- TTL COMPATIBLE INPUTS
- INTEGRAL FAST RECIRCULATION DIODES

### **DESCRIPTION**

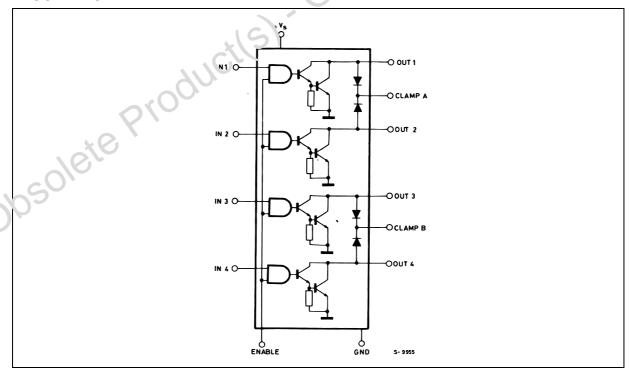
The L6221 monolithic quad darlington switch is designed for high current, high voltage switching applications. Each of the four switches is controlled by a logic input and all four are controlled by a common enable input. All inputs are TTL-compatible for direct connection to logic circuits.

Each switch consists of an open-collector darlington transistor plus a fast diode for switching applications with inductive device loads. The emitters of the four-switches are commoned. Any number of inputs and



outputs of the same device may be paralleled. Three versions are available: the L6221C mounted in a Power tip 12 + 2 + 2 package and the L6221CN mounted in a 15--lead Multiwatt package, the L6221CD in SO16+2+2 package.

### **BLOCK DIAGRAM**

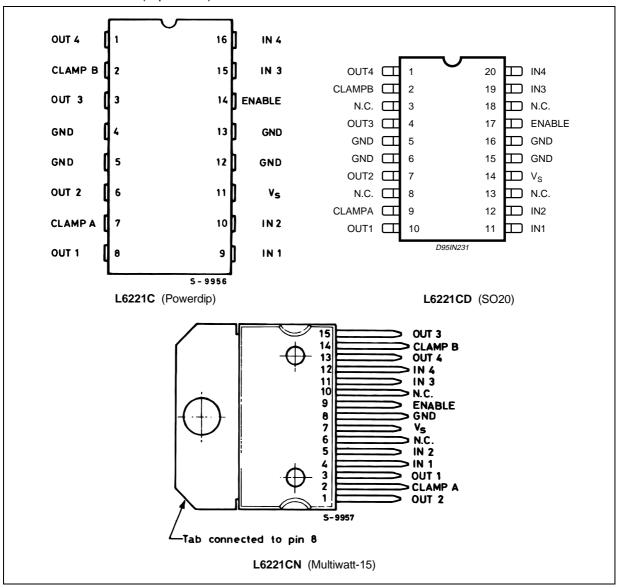


July 2003 1/15

### **THERMAL DATA**

| Symbol                 | Parameter                           |      | SO20 | Powerdip | Multiwatt15 | Unit |
|------------------------|-------------------------------------|------|------|----------|-------------|------|
| R <sub>th j-pins</sub> | Thermal Resistance Junction-pins    | Max. | 17   | 14       | _           | °C/W |
| R <sub>th j-case</sub> | Thermal Resistance Junction-case    | Max. | _    | _        | 3           | °C/W |
| R <sub>th j-amb</sub>  | Thermal Resistance Junction-ambient | Max. | 80   | 80       | 35          | °C/W |

### PIN CONNECTIONS (top views)



## **ABSOLUTE MAXIMUM RATINGS**

| Symbol              | Parameter   | Value                        | Unit        |
|---------------------|---|------------------------------|-------------|
| Vo                  | Output Voltage  | 60                           | V           |
| Vs                  | Logic Supply Voltage  | 7                            | ٧           |
| $V_{IN}$ , $V_{EN}$ | Input Voltage, Enable Voltage   | $V_S$                        |             |
| I <sub>C</sub>      | Continuous Colllector Current (for each channel) for L6221CD  | 1.8<br>1.2                   | A<br>A      |
| Ic                  | Collector Peak Current (repetitive, duty cycle = 10% ton = 5ms) for L6221CD   | 2.5<br>1.7                   | A<br>A      |
| I <sub>C</sub>      | Collector Peak Current (non repetitive, t = 10µs) for L6221CD   | 3.2<br>2.2                   | A<br>A      |
| T <sub>op</sub>     | Operating Temperature Range (junction)  | -40 to +150                  | °C          |
| T <sub>stg</sub>    | Storage Temperature Range   | -55 to +150                  | °C          |
| I <sub>sub</sub>    | Output Substrate Current  | 350                          | mA          |
| P <sub>tot</sub>    | Total Power Dissipation at $T_{pins} = 90^{\circ}C$ (powerdip)<br>at $T_{case} = 90^{\circ}C$ (multiwatt)<br>at $T_{case} = 90^{\circ}C$ (SO20)<br>at $T_{amb} = 70^{\circ}C$ (powerdip)<br>at $T_{amb} = 70^{\circ}C$ (multiwatt)<br>at $T_{amb} = 70^{\circ}C$ (SO20) | 4.3<br>20<br>3.5<br>1<br>2.3 | \$ \$ \$ \$ |

### **TRUTH TABLE**

| Enable | Input | Power Out |
|--------|-------|-----------|
| Н      | Н     | ON        |
| Н      | L     | OFF       |
| L      | X     | OFF       |

For each input : H = High level L = Low levelX = Don't care

## PIN FUNCTIONS (see block diagram)

| Name    | Function                             |
|---------|--------------------------------------|
| IN 1    | Input to Driver 1                    |
| IN 2    | Input to Driver 2                    |
| OUT 1   | Output of Driver 1                   |
| OUT 2   | Output of Driver 2                   |
| CLAMP A | Diode Clamp to Driver 1 and Driver 2 |
| IN 3    | Input to Driver 3                    |
| IN 4    | Input to Driver 4                    |
| OUT 3   | Output of Driver 3                   |
| OUT 4   | Output of Driver 4                   |
| CLAMP B | Diode Clamp to Driver3 and Driver 4  |
| ENABLE  | Enable Input to All Drivers          |
| VS      | Logic Supply Voltage                 |
| GND     | Common Ground                        |



## L6221C

# **ELECTRICAL CHARACTERISTICS** Refer to The Test Circuit to Fig.1 to Fig.9 ( $V_S = 5V$ , $T_{amb} = 25$ °C unless otherwise specified)

| Symbol                               | Parameter                              | Test Condition   | Min. | Тур. | Max.        | Unit     |
|--------------------------------------|--|--|------|------|-------------|----------|
| Vs                                   | Logic Supply Voltage                   |  | 4.5  |      | 5.5         | V        |
| I <sub>S</sub>                       | Logic Supply Current                   | All outputs ON $I_C = 0.7A$<br>All outputs OFF                   |      |      | 20<br>20    | mA<br>mA |
| I <sub>CEX</sub>                     | Output Leakage Current                 | $V_{CE} = 60V$ $V_{EN} = V_{EN}H$<br>$V_{IN} = V_{IN}L$          |      |      | 1           | mA       |
| V <sub>CE(sat)</sub>                 | Collector Emitter Saturation Voltage   | $V_S = 4.5V$ $V_{IN} = V_{IN}H$ $V_{EN} = V_{EN}H$               |      |      |             |          |
|                                      | (one input on; all others inputs off). | $I_{\rm C} = 1A$   |      |      | 1.4<br>1.85 | V<br>V   |
|                                      |  | (*) I <sub>C</sub> = 2A  |      |      |             |          |
| V <sub>IN</sub> L, V <sub>EN</sub> L | Input Low Voltage                      |  |      |      | 8.0         | V        |
| I <sub>IN</sub> L, I <sub>EN</sub> L | Input Low Current                      | $V_{IN} = V_{IN}L$ $V_{EN} = V_{EN}L$                            |      |      | -100        | μΑ       |
| $V_{IN}H$ , $V_{EN}H$                | Input High Voltage                     |  | 2    |      |             | V        |
| I <sub>IN</sub> H, I <sub>EN</sub> H | Input High Current                     | $V_{IN} = V_{IN}H$ $V_{EN} = V_{EN}H$                            |      |      | 100         | μΑ       |
| I <sub>R</sub>                       | Clamp Diode Leakage Current            | $V_R = 60V$ $V_{EN} = V_{EN}H$<br>$V_{IN} = V_{IN}L$             |      |      | 100         | μΑ       |
| V <sub>F</sub>                       | Clamp Diode Forward Voltage            | I <sub>F</sub> = 1A<br>I <sub>F</sub> = 2A (*)                   |      |      | 1.8<br>2.2  | V<br>V   |
| t <sub>d(on)</sub>                   | Turn on Delay Time                     | $V_P = 5V R_L = 10\Omega$  |      |      | 2           | ms       |
| t <sub>d(off)</sub>                  | Turn off Delay Time                    | $V_P = 5V R_L = 10\Omega$  |      |      | 5           | μS       |
| Δls                                  | Logic Supply Current Variation         | $V_{IN} = 5V$ $V_{EN} = 5V$ $I_{out} = -500$ mA for Each Channel |      |      | 150         | mA       |

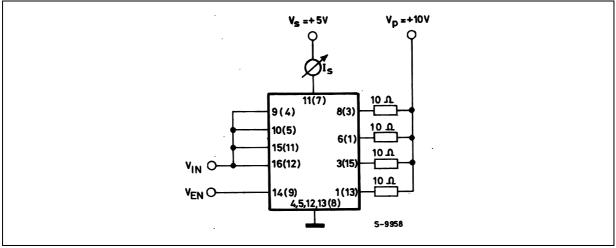
<sup>(\*)</sup> Only for L6221C - L6221CN types

### **TEST CIRCUITS**

(X) = Referred to Multiwatt package

X = Referred to Powerdip package

Figure 1 : Logic supply current.



 $\overline{S_{\text{et}} \ V_{\text{IN}} = 4.5 \text{V, V}_{\text{EN}} = 0.8 \text{V, or V}_{\text{IN}} = 0.8 \text{V, V}_{\text{EN}} = 4.5 \text{V, for I}_{\text{S}} \ \text{(all outputs off)}} \\ S_{\text{et}} \ V_{\text{IN}} = 2 \text{V, V}_{\text{EN}} = 2 \text{V, for I}_{\text{S}} \ \text{(all outputs on)}}$ 

Figure 2: Output Sustaining Voltage.

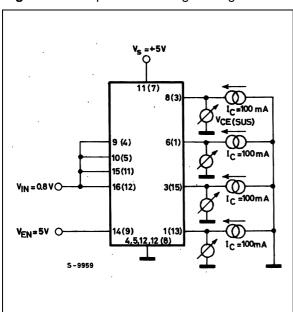
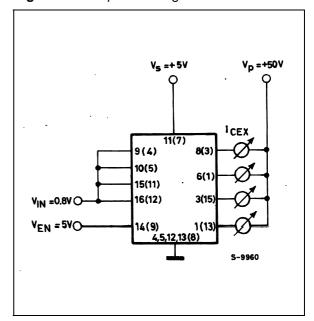


Figure 3: Output Leakage Current.



 $V_P = +60V$ 

Figure 4 : Collector-emitter Saturation Voltage.

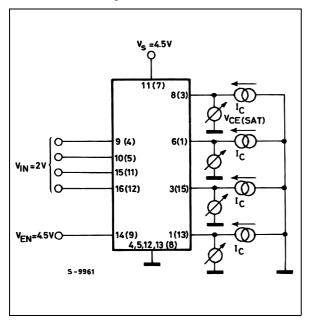
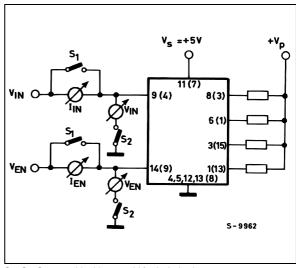


Figure 5: Logic Input Characteristics.



 $\begin{array}{l} S_{et} \; S_1, \, S_2 \; open, \, V_{IN}, \, V_{EN} = 0.8V \; for \; I_{IN} \; L, \, I_{EN} \; L \\ S_{et} \; S_1, \, S_2 \; open, \, V_{IN}, \, V_{EN} = 2V \; for \; I_{IN} \; H, \, I_{EN} \; H \\ S_{et} \; S_1, \, S_2 \; close, \, V_{IN}, \, V_{EN} = 0.8V \; for \; V_{IN} \; L, \, V_{EN} \; L \\ \end{array}$ 

 $S_{et}$   $S_1$ ,  $S_2$  close,  $V_{IN}$ ,  $V_{EN}$  = 2V for  $V_{IN}$  H,  $V_{EN}$  H

Figure 6 : Clamp Diode Leakage Current.

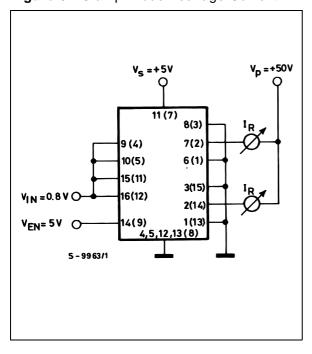
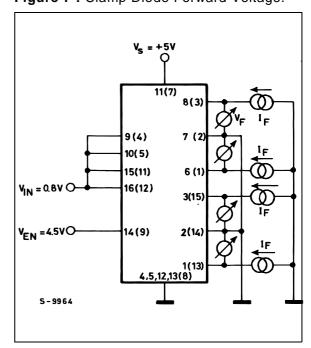


Figure 7: Clamp Diode Forward Voltage.



 $V_P = +60V$ 

Figure 8: Switching Times Test Circuit.

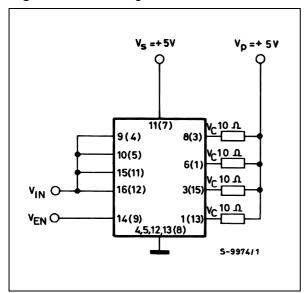


Figure 10: Allowed Peak Collector Current vs. Duty Cycle for 1, 2, 3 or 4 Contemporary Working Outputs (L6221C).

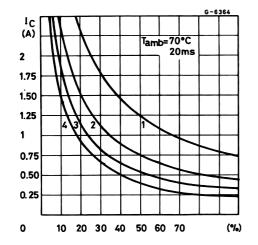


Figure 9: Switching TImes Waveforms.

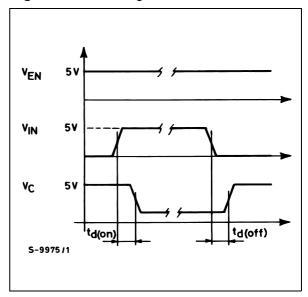
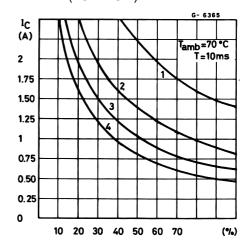


Figure 11: Allowed Peak Collector Current vs. Duty Cycle for 1, 2, 3 or 4 Contemporary Working Outputs (L6221CN).



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Figure 12 : Collector Saturation Voltage vs. Collector Current.

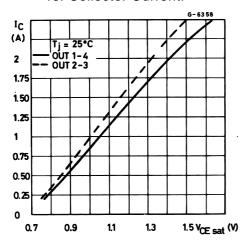


Figure 14 : Collector Saturation Voltage vs. Junction Temperature at I<sub>C</sub> = 1A.

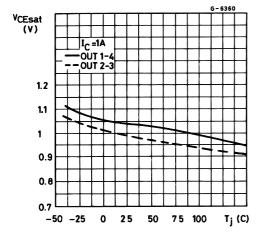


Figure 16: Saturation Voltage vs. Junction Temperature at IC = 1.8A.

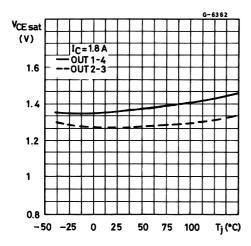


Figure 13 : Free-wheeling Diode Forward Voltage vs. Diode Current .

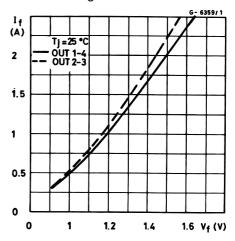


Figure 15: Free-wheeling Diode Forward Voltage vs. Junction Temperature at I<sub>F</sub> = 1A.

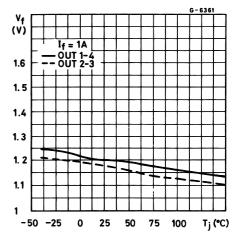
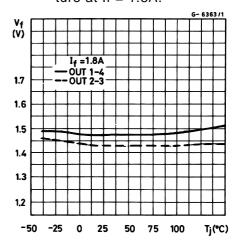
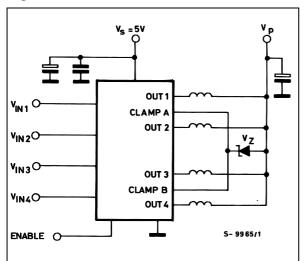


Figure 17: Free-wheeling Diode Forward Voltage vs. Junction Temperature at If = 1.8A.



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Figure 18.



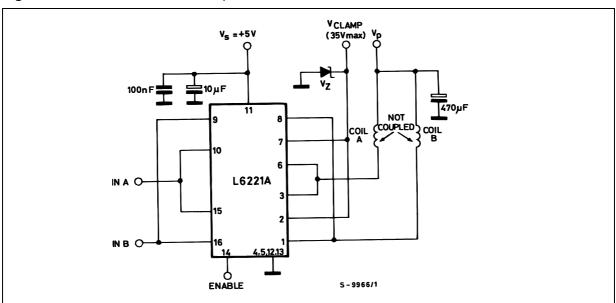
#### **APPLICATION INFORMATION**

When inductive loads are driven by L6221C/CD, a zener diode in series with the integral free-wheeling diodes increases the voltage across which energy stored in the load is discharged and therefore speeds the current decay (fig. 18).

The zener has to be chosen in such a way that  $V_{\text{CLAMP}}$  is limited to 60V taking into account the zener's voltage changes due to: spread on  $V_Z$ , temperature changes, and the voltage drop due to ohmic resistance.

Moreover, the instantaneous power must be limited in order to avoid the reverse second breakdown.

Figure 19: Driver for Solenoids up to 3A.



Some care must be taken to ensure that the collectors are placed close together to avoid different current partitioning at turn-off.

We suggest to put in parallel channel 1 and 4 and channel 2 and 3 as shown in figure 19 for the similar

electrical characteristics of the logic section (turn-on and turn-off delay time) and the power stages (collector saturation voltage, free-wheeling diode forward voltage).

Figure 20 : Saturation Voltage vs. Collector Current.

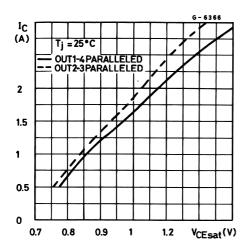


Figure 22: Peak Collector Current vs.
Duty Cycle for 1 or 2 Paralleled
Outputs Driven (L6221CN).

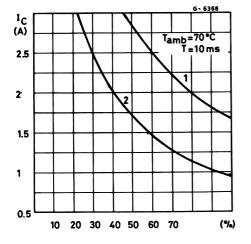
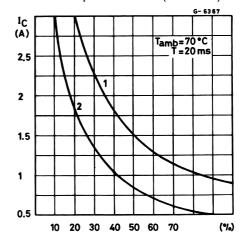


Figure 21: Peak Collector Current vs.
Duty Cycle for 1 or 2 Paralleled
Outputs Driven (L6221N).



### **MOUNTING INSTRUCTION**

The R<sub>th j-amb</sub> of the L6221C can be reduced by soldering the GND pins to a suitable copper area of the printed circuit board (Fig. 23) or to an external heatsink (Fig. 24).

The diagram of figure 25 shows the maximum dissipable power  $P_{tot}$  and the  $R_{th\ j\text{-}amb}$  as a function of the side "  $\alpha$ " of two equal square copper areas hav-

Figure 23: Example of P.C. Board Copper Area Which is Used as Heatsink.

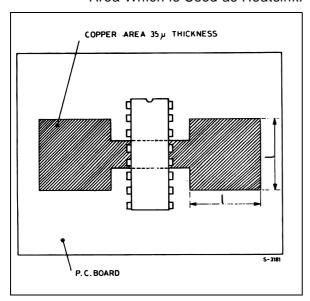
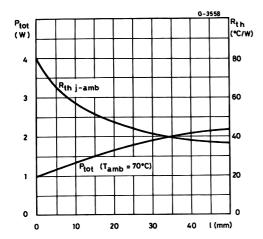


Figure 25 : Maximum Dissipable Power and Junction to Ambient Thermal Resistance vs. Side "  $\alpha$ ".



ing a thickness of  $35\mu\,$  (1.4 mils). During soldering the pins temperature must not exceed 260 °C and the soldering time must not be longer than 12 seconds

The external heatsink or printed circuit copper area must be connected to electrical ground.

**Figure 24 :** External Heatsink Mounting Example.

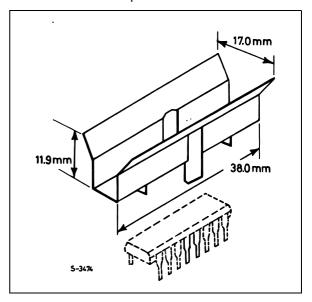
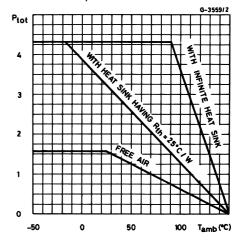
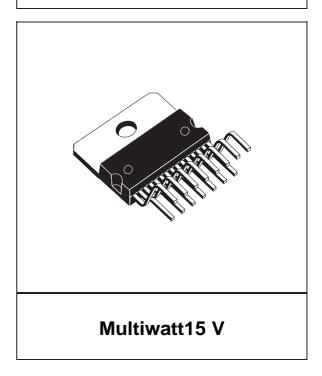


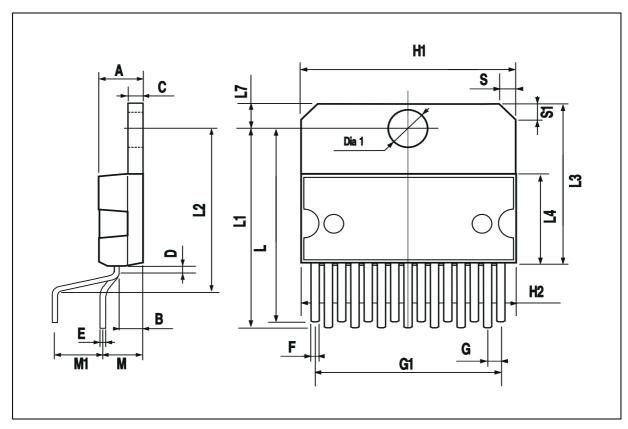
Figure 26: Maximum Allowable Power Dissipation vs. Ambient Temperature.



| DIM.   |       | mm    |       |       | inch  |       |
|--------|-------|-------|-------|-------|-------|-------|
| DIIVI. | MIN.  | TYP.  | MAX.  | MIN.  | TYP.  | MAX.  |
| Α      |       |       | 5     |       |       | 0.197 |
| В      |       |       | 2.65  |       |       | 0.104 |
| С      |       |       | 1.6   |       |       | 0.063 |
| D      |       | 1     |       |       | 0.039 |       |
| Е      | 0.49  |       | 0.55  | 0.019 |       | 0.022 |
| F      | 0.66  |       | 0.75  | 0.026 |       | 0.030 |
| G      | 1.02  | 1.27  | 1.52  | 0.040 | 0.050 | 0.060 |
| G1     | 17.53 | 17.78 | 18.03 | 0.690 | 0.700 | 0.710 |
| H1     | 19.6  |       |       | 0.772 |       |       |
| H2     |       |       | 20.2  |       |       | 0.795 |
| L      | 21.9  | 22.2  | 22.5  | 0.862 | 0.874 | 0.886 |
| L1     | 21.7  | 22.1  | 22.5  | 0.854 | 0.870 | 0.886 |
| L2     | 17.65 |       | 18.1  | 0.695 |       | 0.713 |
| L3     | 17.25 | 17.5  | 17.75 | 0.679 | 0.689 | 0.699 |
| L4     | 10.3  | 10.7  | 10.9  | 0.406 | 0.421 | 0.429 |
| L7     | 2.65  |       | 2.9   | 0.104 |       | 0.114 |
| М      | 4.25  | 4.55  | 4.85  | 0.167 | 0.179 | 0.191 |
| M1     | 4.63  | 5.08  | 5.53  | 0.182 | 0.200 | 0.218 |
| S      | 1.9   |       | 2.6   | 0.075 |       | 0.102 |
| S1     | 1.9   |       | 2.6   | 0.075 |       | 0.102 |
| Dia1   | 3.65  |       | 3.85  | 0.144 |       | 0.152 |

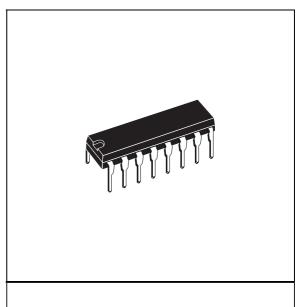
# OUTLINE AND MECHANICAL DATA



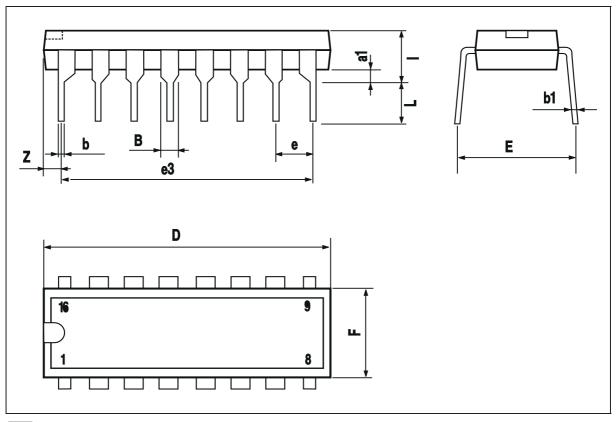


| DIM. |      | mm    |      | inch  |       |       |
|------|------|-------|------|-------|-------|-------|
|      | MIN. | TYP.  | MAX. | MIN.  | TYP.  | MAX.  |
| a1   | 0.51 |       |      | 0.020 |       |       |
| В    | 0.85 |       | 1.40 | 0.033 |       | 0.055 |
| b    |      | 0.50  |      |       | 0.020 |       |
| b1   | 0.38 |       | 0.50 | 0.015 |       | 0.020 |
| D    |      |       | 20.0 |       |       | 0.787 |
| Е    |      | 8.80  |      |       | 0.346 |       |
| е    |      | 2.54  |      |       | 0.100 |       |
| e3   |      | 17.78 |      |       | 0.700 |       |
| F    |      |       | 7.10 |       |       | 0.280 |
| I    |      |       | 5.10 |       |       | 0.201 |
| L    |      | 3.30  |      |       | 0.130 |       |
| Z    |      |       | 1.27 |       |       | 0.050 |

# OUTLINE AND MECHANICAL DATA

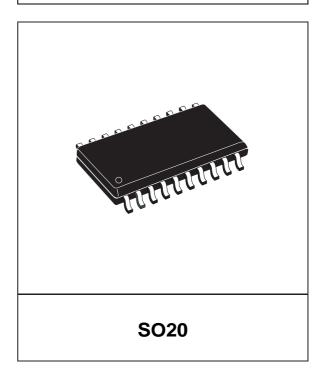


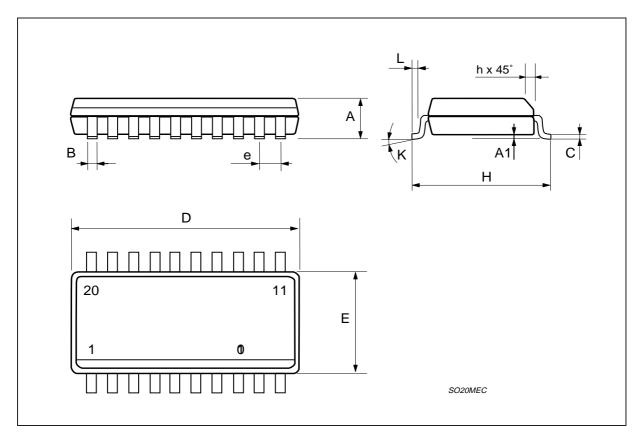
Powerdip 16



| DIM. | mm                 |      |       | inch  |       |       |
|------|--------------------|------|-------|-------|-------|-------|
|      | MIN.               | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| Α    | 2.35               |      | 2.65  | 0.093 |       | 0.104 |
| A1   | 0.1                |      | 0.3   | 0.004 |       | 0.012 |
| В    | 0.33               |      | 0.51  | 0.013 |       | 0.020 |
| С    | 0.23               |      | 0.32  | 0.009 |       | 0.013 |
| D    | 12.6               |      | 13    | 0.496 |       | 0.512 |
| Е    | 7.4                |      | 7.6   | 0.291 |       | 0.299 |
| е    |                    | 1.27 |       |       | 0.050 |       |
| Н    | 10                 |      | 10.65 | 0.394 |       | 0.419 |
| h    | 0.25               |      | 0.75  | 0.010 |       | 0.030 |
| L    | 0.4                |      | 1.27  | 0.016 |       | 0.050 |
| K    | 0° (min.)8° (max.) |      |       |       |       |       |

# OUTLINE AND MECHANICAL DATA





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